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4/22/02 Janita C. Beall  
Date Signature

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Serial No. 10/099861  
(Attorney Docket No. DP-305031)

Filed 3/15/02

Inventors: SHING YEH  
BRADLEY H. CARTER  
CURTIS W. MELCHER

Title: LEAD-FREE SOLDER ALLOY AND SOLDER REFLOW PROCESS

Enclosed to complete this patent application is a Declaration. Please charge \$ 1284.00 filing fee  
and surcharge to DELPHI TECHNOLOGIES, INC. Deposit Account No. 50-0831.

Filing Fee Formula

Basic Fee.....	\$ 740.00
Additional Fees:	
Number of independent claims in excess of 3, times \$84.00 .....	\$ 0.00
Number of claims in excess of 20, times \$18.00 .....	\$ 414.00
Multiple dependent claim (N), add \$280.00 .....	\$ 0.00
Total Filing Fee.....	\$ 1154.00
Surcharge .....	\$ 130.00
Total .....	\$ 1284.00

The application Serial No. 10/099861 filed 3/15/02 in the Patent and Trademark  
Office is the application for which the inventor(s) executed the Declaration enclosed herewith.

Jimmy L. Funke  
JIMMY L. FUNKE  
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Enclosures



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS  
UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231  
www.uspto.gov

APPLICATION NUMBER

FILING/RECEIPT DATE

FIRST NAMED APPLICANT

ATTORNEY DOCKET NUMBER

10/099,861

03/15/2002

Shing Yeh

DP-305031

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CONFIRMATION NO. 4475

FORMALITIES LETTER



\*OC000000007877988\*

Reply Due 6/17/02  
Date Mailed: 04/17/2002

### NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

05/02/2002 AOSMAN1 00000037 500831 10099861

01 FC:101 740.00 CH  
02 FC:103 414.00 CH  
03 FC:105 130.00 CH

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The statutory basic filing fee is missing.  
*Applicant must submit \$ 740 to complete the basic filing fee for a non-small entity. If appropriate, applicant may make a written assertion of entitlement to small entity status and pay the small entity filing fee (37 CFR 1.27).*
- Total additional claim fee(s) for this application is \$414.  
    ■ \$414 for 23 total claims over 20.
- The oath or declaration is missing.  
*A properly signed oath or declaration in compliance with 37 CFR 1.63, identifying the application by the above Application Number and Filing Date, is required.*
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.  
**The balance due by applicant is \$ 1284.**

*A copy of this notice **MUST** be returned with the reply.*

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